

# 74LVC623A-Q100

Octal transceiver with dual enable; 3-state

Rev. 1 — 17 April 2013

Product data sheet

## 1. General description

The 74LVC623A-Q100 is an octal transceiver featuring non-inverting 3-state bus compatible outputs in both send and receive directions. This octal bus transceiver is designed for asynchronous two-way communication between data buses.

The control function implementation allows maximum flexibility in timing. This device allows data transmission from the An bus to the Bn bus or from the Bn bus to the An bus. The data flow direction depends on the logic levels at the enable inputs (pins OEAB and OEBA). The enable inputs can be used to disable the device so that the buses are effectively isolated. The dual enable function configuration gives this transceiver the capability to store data by simultaneous enabling of pins OEAB and OEBA. Each output reinforces its input in this transceiver configuration. Thus, when both control inputs are enabled and all other data sources to the two sets of the bus lines are at high-impedance OFF-state, both sets of the bus lines remain at their last states. The 8-bit codes on the two sets of buses are identical.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V or 5 V applications.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

## 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - ◆ Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$  and from  $-40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$
- 5 V tolerant inputs and outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- High-impedance when  $V_{CC} = 0\text{ V}$
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - ◆ JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - ◆ MIL-STD-883, method 3015 exceeds 2000 V
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V ( $C = 200\text{ pF}$ ,  $R = 0\text{ }\Omega$ )



## 3. Ordering information

Table 1. Ordering information

| Type number      | Package           |         |  | Version  |
|------------------|-------------------|---------|--|----------|
|                  | Temperature range | Name    | Description  |          |
| 74LVC623AD-Q100  | -40 °C to +125 °C | SO20    | plastic small outline package; 20 leads; body width 7.5 mm             | SOT163-1 |
| 74LVC623ADB-Q100 | -40 °C to +125 °C | SSOP20  | plastic shrink small outline package; 20 leads; body width 5.3 mm      | SOT339-1 |
| 74LVC623APW-Q100 | -40 °C to +125 °C | TSSOP20 | plastic thin shrink small outline package; 20 leads; body width 4.4 mm | SOT360-1 |

## 4. Functional diagram

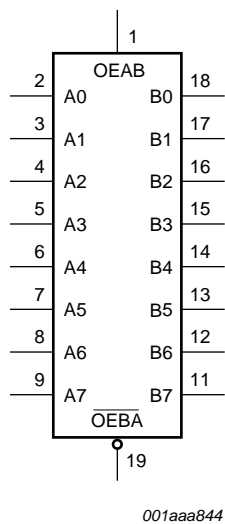


Fig 1. Logic symbol

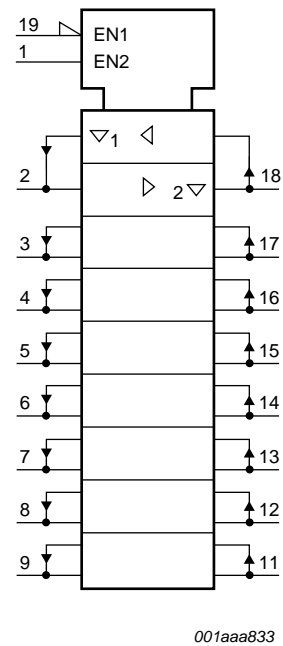
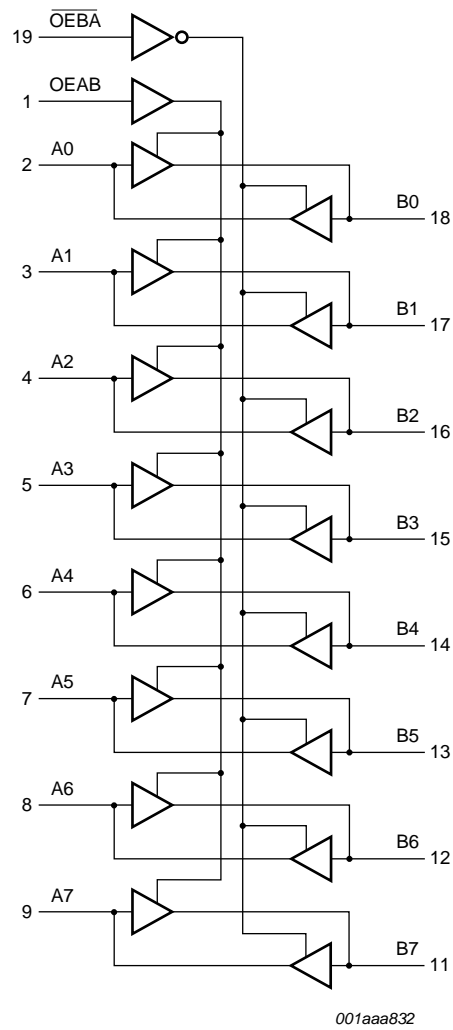


Fig 2. IEC logic symbol



**Fig 3. Logic diagram**

## 5. Pinning information

### 5.1 Pinning

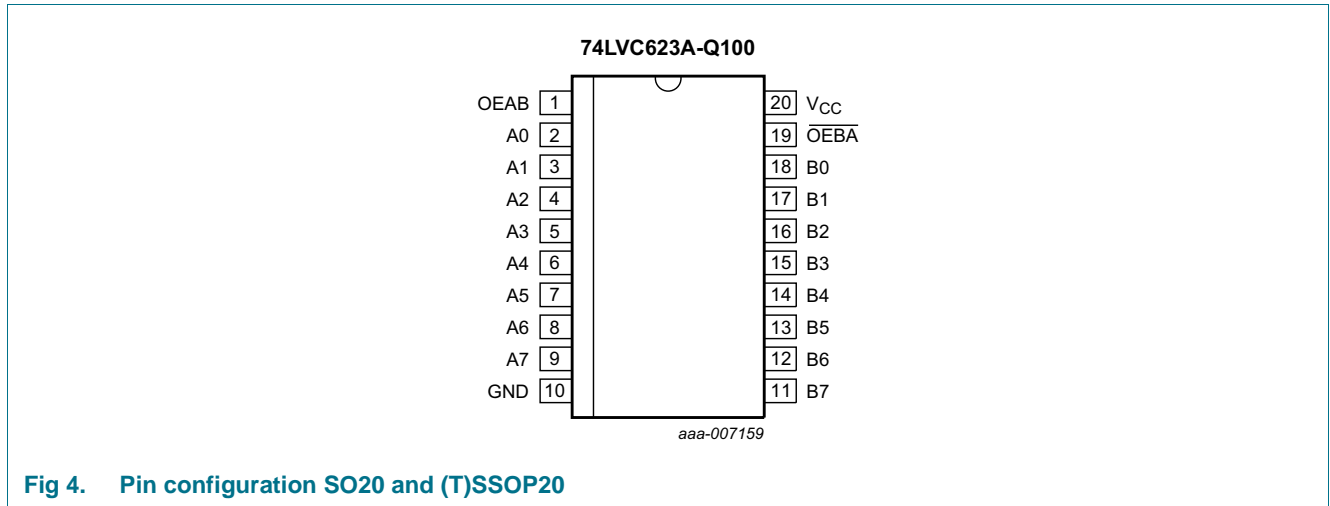


Fig 4. Pin configuration SO20 and (T)SSOP20

### 5.2 Pin description

Table 2. Pin description

| Pin    | Symbol                         | Description                      |
|--------|--------------------------------|----------------------------------|
| 1      | OEAB                           | output enable input              |
| 19     | $\overline{\text{OEBA}}$       | output enable input (active LOW) |
| A[0:7] | 2, 3, 4, 5, 6, 7, 8, 9         | data input or output             |
| B[0:7] | 18, 17, 16, 15, 14, 13, 12, 11 | data output or input             |
| 10     | GND                            | ground (0 V)                     |
| 20     | V <sub>CC</sub>                | supply voltage                   |

## 6. Functional description

Table 3. Function table<sup>[1]</sup>

| Input |                          | Input or output |         |
|-------|--------------------------|-----------------|---------|
| OEAB  | $\overline{\text{OEBA}}$ | An              | Bn      |
| L     | L                        | An = Bn         | input   |
| H     | H                        | input           | Bn = An |
| L     | H                        | Z               | Z       |
| H     | L                        | An = Bn         | input   |
|       |                          | input           | Bn = An |

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state

## 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions                      | Min      | Max            | Unit |
|-----------|-------------------------|---------------------------------|----------|----------------|------|
| $V_{CC}$  | supply voltage          |                                 | -0.5     | +6.5           | V    |
| $V_I$     | input voltage           |                                 | [1] -0.5 | +6.5           | V    |
| $V_O$     | output voltage          | HIGH or LOW state               | [2] -0.5 | $V_{CC} + 0.5$ | V    |
|           |                         | 3-state                         | [2] -0.5 | +6.5           | V    |
| $I_{IK}$  | input clamping current  | $V_I < 0$ V                     | -50      | -              | mA   |
| $I_{OK}$  | output clamping current | $V_O > V_{CC}$ or $V_O < 0$ V   | -        | $\pm 50$       | mA   |
| $I_O$     | output current          | $V_O = 0$ V to $V_{CC}$         | -        | $\pm 50$       | mA   |
| $I_{CC}$  | supply current          |                                 | -        | 100            | mA   |
| $I_{GND}$ | ground current          |                                 | -100     | -              | mA   |
| $T_{stg}$ | storage temperature     |                                 | -65      | $\pm 150$      | °C   |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40$ °C to $+125$ °C | [3] -    | 500            | mW   |

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO20 package: above 70 °C  $P_{tot}$  derates linearly with 8 mW/K.  
For (T)SSOP20 packages: above 60 °C  $P_{tot}$  derates linearly with 5.5 mW/K.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

| Symbol           | Parameter                           | Conditions                        | Min  | Typ | Max             | Unit |
|------------------|-------------------------------------|-----------------------------------|------|-----|-----------------|------|
| V <sub>CC</sub>  | supply voltage                      |                                   | 1.65 | -   | 3.6             | V    |
|                  |                                     | functional                        | 1.2  | -   | -               | V    |
| V <sub>I</sub>   | input voltage                       |                                   | 0    | -   | 5.5             | V    |
| V <sub>O</sub>   | output voltage                      | HIGH or LOW state                 | 0    | -   | V <sub>CC</sub> | V    |
|                  |                                     | 3-state or V <sub>CC</sub> = 0 V  | 0    | -   | 5.5             | V    |
| T <sub>amb</sub> | ambient temperature                 | in free air                       | -40  | -   | +125            | °C   |
| Δt/ΔV            | input transition rise and fall rate | V <sub>CC</sub> = 1.65 V to 2.7 V | 0    | -   | 20              | ns/V |
|                  |                                     | V <sub>CC</sub> = 2.7 V to 3.6 V  | 0    | -   | 10              | ns/V |

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                 | Conditions  | -40 °C to +85 °C       |                    |                        | -40 °C to +125 °C      |                        | Unit |
|-----------------|---------------------------|---|------------------------|--------------------|------------------------|------------------------|------------------------|------|
|                 |                           |   | Min                    | Typ <sup>[1]</sup> | Max                    | Min                    | Max                    |      |
| V <sub>IH</sub> | HIGH-level input voltage  | V <sub>CC</sub> = 1.2 V                                     | 1.08                   | -                  | -                      | 1.08                   | -                      | V    |
|                 |                           | V <sub>CC</sub> = 1.65 V to 1.95 V                          | 0.65 × V <sub>CC</sub> | -                  | -                      | 0.65 × V <sub>CC</sub> | -                      | V    |
|                 |                           | V <sub>CC</sub> = 2.3 V to 2.7 V                            | 1.7                    | -                  | -                      | 1.7                    | -                      | V    |
|                 |                           | V <sub>CC</sub> = 2.7 V to 3.6 V                            | 2.0                    | -                  | -                      | 2.0                    | -                      | V    |
| V <sub>IL</sub> | LOW-level input voltage   | V <sub>CC</sub> = 1.2 V                                     | -                      | -                  | 0.12                   | -                      | 0.12                   | V    |
|                 |                           | V <sub>CC</sub> = 1.65 V to 1.95 V                          | -                      | -                  | 0.35 × V <sub>CC</sub> | -                      | 0.35 × V <sub>CC</sub> | V    |
|                 |                           | V <sub>CC</sub> = 2.3 V to 2.7 V                            | -                      | -                  | 0.7                    | -                      | 0.7                    | V    |
|                 |                           | V <sub>CC</sub> = 2.7 V to 3.6 V                            | -                      | -                  | 0.8                    | -                      | 0.8                    | V    |
| V <sub>OH</sub> | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>         |                        |                    |                        |                        |                        |      |
|                 |                           | I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V | V <sub>CC</sub> - 0.2  | -                  | -                      | V <sub>CC</sub> - 0.3  | -                      | V    |
|                 |                           | I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 1.65 V            | 1.2                    | -                  | -                      | 1.05                   | -                      | V    |
|                 |                           | I <sub>O</sub> = -8 mA; V <sub>CC</sub> = 2.3 V             | 1.8                    | -                  | -                      | 1.65                   | -                      | V    |
|                 |                           | I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V            | 2.2                    | -                  | -                      | 2.05                   | -                      | V    |
|                 |                           | I <sub>O</sub> = -18 mA; V <sub>CC</sub> = 3.0 V            | 2.4                    | -                  | -                      | 2.25                   | -                      | V    |
| V <sub>OL</sub> | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>         |                        |                    |                        |                        |                        |      |
|                 |                           | I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V  | -                      | -                  | 0.2                    | -                      | 0.3                    | V    |
|                 |                           | I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V             | -                      | -                  | 0.45                   | -                      | 0.65                   | V    |
|                 |                           | I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V              | -                      | -                  | 0.6                    | -                      | 0.8                    | V    |
|                 |                           | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V             | -                      | -                  | 0.4                    | -                      | 0.6                    | V    |
|                 |                           | I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V             | -                      | -                  | 0.55                   | -                      | 0.8                    | V    |
| I <sub>I</sub>  | input leakage current     | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 5.5 V or GND      | -                      | ±0.1               | ±5                     | -                      | ±20                    | μA   |

**Table 6. Static characteristics ...continued**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                 | Conditions  | -40 °C to +85 °C |                    |     | -40 °C to +125 °C |      | Unit |
|------------------|---------------------------|---|------------------|--------------------|-----|-------------------|------|------|
|                  |                           |   | Min              | Typ <sup>[1]</sup> | Max | Min               | Max  |      |
| I <sub>OZ</sub>  | OFF-state output current  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 3.6 V; V <sub>O</sub> = 5.5 V or GND; [2] | -                | 0.1                | ±5  | -                 | ±20  | µA   |
| I <sub>OFF</sub> | power-off leakage current | V <sub>CC</sub> = 0 V; V <sub>I</sub> or V <sub>O</sub> = 5.5 V   | -                | 0.1                | ±10 | -                 | ±20  | µA   |
| I <sub>CC</sub>  | supply current            | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A                            | -                | 0.1                | 10  | -                 | 40   | µA   |
| ΔI <sub>CC</sub> | additional supply current | per input pin; V <sub>CC</sub> = 2.7 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A   | -                | 5                  | 500 | -                 | 5000 | µA   |
| C <sub>I</sub>   | input capacitance         | V <sub>CC</sub> = 0 V to 3.6 V; V <sub>I</sub> = GND to V <sub>CC</sub>   | -                | 4.0                | -   | -                 | -    | pF   |
| C <sub>I/O</sub> | input/output capacitance  | V <sub>CC</sub> = 0 V to 3.6 V; V <sub>I</sub> = GND to V <sub>CC</sub>   | -                | 10.0               | -   | -                 | -    | pF   |

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

[2] For transceivers, the parameter I<sub>OZ</sub> includes the input leakage current.

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see [Figure 8](#).

| Symbol                           | Parameter         | Conditions   | -40 °C to +85 °C |                    |      | -40 °C to +125 °C |      | Unit |
|----------------------------------|-------------------|--|------------------|--------------------|------|-------------------|------|------|
|                                  |                   |  | Min              | Typ <sup>[1]</sup> | Max  | Min               | Max  |      |
| t <sub>pd</sub>                  | propagation delay | An to Bn; Bn to An; see <a href="#">Figure 5</a> [2] |                  |                    |      |                   |      |      |
|                                  |                   | V <sub>CC</sub> = 1.2 V                              | -                | 19                 | -    | -                 | -    | ns   |
|                                  |                   | V <sub>CC</sub> = 1.65 V to 1.95 V                   | 1.7              | 6.4                | 13.5 | 1.7               | 14.2 | ns   |
|                                  |                   | V <sub>CC</sub> = 2.3 V to 2.7 V                     | 1.5              | 3.4                | 6.7  | 1.5               | 7.4  | ns   |
|                                  |                   | V <sub>CC</sub> = 2.7 V                              | 1.5              | 3.4                | 5.7  | 1.5               | 7.5  | ns   |
|                                  |                   | V <sub>CC</sub> = 3.0 V to 3.6 V                     | 1.0              | 2.9                | 5.2  | 1.0               | 6.5  | ns   |
| t <sub>en</sub>                  | enable time       | OEAB to Bn; see <a href="#">Figure 6</a> [2]         |                  |                    |      |                   |      |      |
|                                  |                   | V <sub>CC</sub> = 1.2 V                              | -                | 26                 | -    | -                 | -    | ns   |
|                                  |                   | V <sub>CC</sub> = 1.65 V to 1.95 V                   | 2.7              | 8.7                | 17.0 | 2.7               | 17.9 | ns   |
|                                  |                   | V <sub>CC</sub> = 2.3 V to 2.7 V                     | 2.2              | 4.8                | 8.9  | 2.2               | 9.8  | ns   |
|                                  |                   | V <sub>CC</sub> = 2.7 V                              | 1.5              | 4.2                | 6.9  | 1.5               | 9.0  | ns   |
|                                  |                   | V <sub>CC</sub> = 3.0 V to 3.6 V                     | 1.0              | 3.9                | 6.6  | 1.0               | 8.5  | ns   |
|                                  |                   | OEBA to An; see <a href="#">Figure 7</a> [2]         |                  |                    |      |                   |      |      |
|                                  |                   | V <sub>CC</sub> = 1.2 V                              | -                | 26                 | -    | -                 | -    | ns   |
|                                  |                   | V <sub>CC</sub> = 1.65 V to 1.95 V                   | 2.6              | 8.1                | 17.0 | 2.6               | 17.9 | ns   |
|                                  |                   | V <sub>CC</sub> = 2.3 V to 2.7 V                     | 2.2              | 4.5                | 8.9  | 2.2               | 9.8  | ns   |
|                                  |                   | V <sub>CC</sub> = 2.7 V                              | 1.5              | 4.6                | 7.5  | 1.5               | 9.5  | ns   |
| V <sub>CC</sub> = 3.0 V to 3.6 V | 1.0               | 3.6  | 6.6              | 1.0                | 8.5  | ns                |      |      |

**Table 7. Dynamic characteristics ...continued**

Voltages are referenced to GND (ground = 0 V). For test circuit see [Figure 8](#).

| Symbol             | Parameter                     | Conditions  | -40 °C to +85 °C |                    |      | -40 °C to +125 °C |      | Unit |
|--------------------|-------------------------------|---|------------------|--------------------|------|-------------------|------|------|
|                    |                               |   | Min              | Typ <sup>[1]</sup> | Max  | Min               | Max  |      |
| t <sub>dis</sub>   | disable time                  | OEAB to Bn; see <a href="#">Figure 6</a> <sup>[2]</sup>           |                  |                    |      |                   |      |      |
|                    |                               | V <sub>CC</sub> = 1.2 V   | -                | 12                 | -    | -                 | -    | ns   |
|                    |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                | 2.3              | 4.7                | 10.5 | 2.3               | 11.1 | ns   |
|                    |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                                  | 1.0              | 2.6                | 5.7  | 1.0               | 6.4  | ns   |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 1.5              | 4.2                | 6.2  | 1.5               | 8.0  | ns   |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                  | 1.0              | 3.2                | 5.5  | 1.0               | 7.0  | ns   |
|                    |                               | OEBA to An; see <a href="#">Figure 7</a> <sup>[2]</sup>           |                  |                    |      |                   |      |      |
|                    |                               | V <sub>CC</sub> = 1.2 V   | -                | 11                 | -    | -                 | -    | ns   |
|                    |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                | 3.6              | 5.2                | 10.1 | 3.6               | 10.7 | ns   |
|                    |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                                  | 1.0              | 2.9                | 5.5  | 1.0               | 6.1  | ns   |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 1.5              | 3.7                | 5.5  | 1.5               | 7.0  | ns   |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                  | 1.0              | 3.4                | 5.3  | 1.0               | 7.0  | ns   |
| t <sub>sk(o)</sub> | output skew time              | V <sub>CC</sub> = 3.0 V to 3.6 V <sup>[3]</sup>                   | -                | -                  | 1.0  | -                 | 1.5  | ns   |
| C <sub>PD</sub>    | power dissipation capacitance | per input; V <sub>I</sub> = GND to V <sub>CC</sub> <sup>[4]</sup> |                  |                    |      |                   |      |      |
|                    |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                | -                | 11.9               | -    | -                 | -    | pF   |
|                    |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                                  | -                | 15.5               | -    | -                 | -    | pF   |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                  | -                | 18.8               | -    | -                 | -    | pF   |

[1] Typical values are measured at T<sub>amb</sub> = 25 °C and V<sub>CC</sub> = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

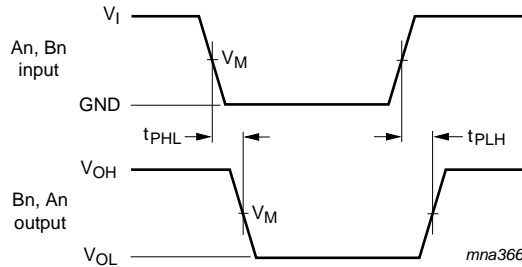
[2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.  
 t<sub>en</sub> is the same as t<sub>PZL</sub> and t<sub>PZH</sub>.  
 t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>.

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

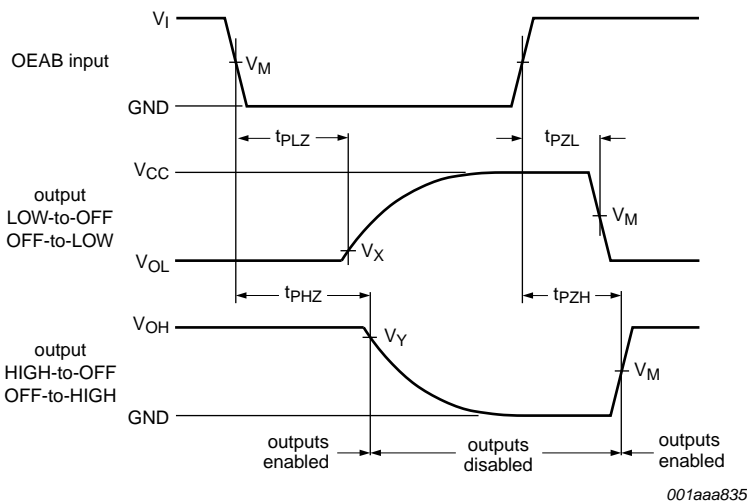
$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:  
 f<sub>i</sub> = input frequency in MHz; f<sub>o</sub> = output frequency in MHz  
 C<sub>L</sub> = output load capacitance in pF  
 V<sub>CC</sub> = supply voltage in Volts  
 N = number of inputs switching  
 Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) = sum of the outputs

11. Waveforms



$V_M = 1.5\text{ V}$  at  $V_{CC} \geq 2.7\text{ V}$ ;  
 $V_M = 0.5 \times V_{CC}$  at  $V_{CC} < 2.7\text{ V}$ .  
 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig 5. The inputs An, Bn to outputs Bn, An propagation delays

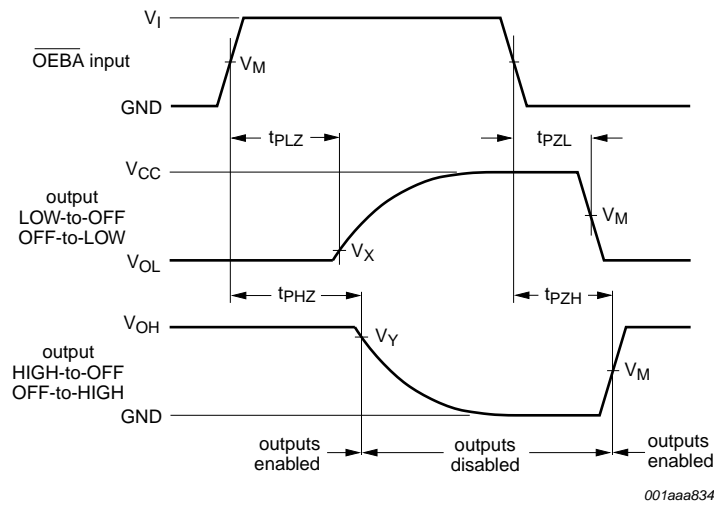


Measurement points are given in [Table 8](#).  
 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig 6. 3-state enable and disable times for OEAB input

Table 8. Measurement points

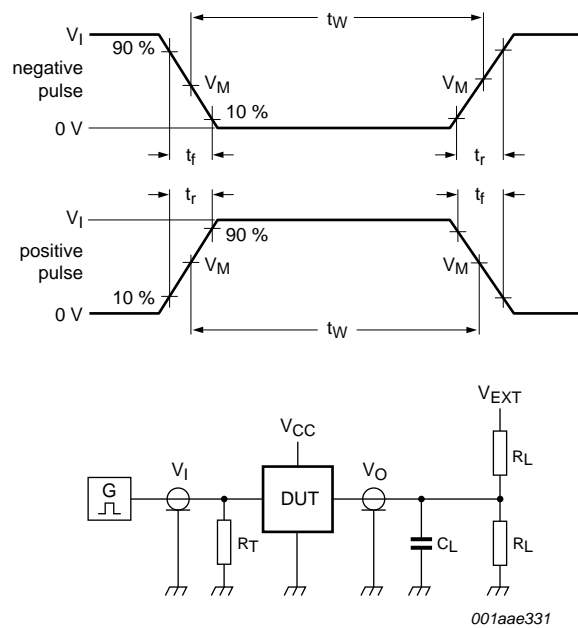
| Supply voltage      | Input               | Output              |                          |                          |
|---------------------|---------------------|---------------------|--------------------------|--------------------------|
| $V_{CC}$            | $V_M$               | $V_M$               | $V_X$                    | $V_Y$                    |
| $< 2.7\text{ V}$    | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | $V_{OL} + 0.15\text{ V}$ | $V_{OH} - 0.15\text{ V}$ |
| $\geq 2.7\text{ V}$ | $1.5\text{ V}$      | $1.5\text{ V}$      | $V_{OL} + 0.3\text{ V}$  | $V_{OH} - 0.3\text{ V}$  |



Measurement points are given in [Table 8](#).

$V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 7. 3-state enable and disable times for OEBA input**



Test data is given in [Table 9](#).

Definitions for test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$V_{EXT}$  = External voltage for measuring switching times.

**Fig 8. Test circuit for measuring switching times**

**Table 9. Test data**

| Supply voltage   | Input    |               | Load  |              | $V_{EXT}$          |                    |                    |
|------------------|----------|---------------|-------|--------------|--------------------|--------------------|--------------------|
|                  | $V_I$    | $t_r, t_f$    | $C_L$ | $R_L$        | $t_{PLH}, t_{PHL}$ | $t_{PLZ}, t_{PZL}$ | $t_{PHZ}, t_{PZH}$ |
| 1.2 V            | $V_{CC}$ | $\leq 2$ ns   | 30 pF | 1 k $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 1.65 V to 1.95 V | $V_{CC}$ | $\leq 2$ ns   | 30 pF | 1 k $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 2.3 V to 2.7 V   | $V_{CC}$ | $\leq 2$ ns   | 30 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 2.7 V            | 2.7 V    | $\leq 2.5$ ns | 50 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 3.0 V to 3.6 V   | 2.7 V    | $\leq 2.5$ ns | 50 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |

12. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1

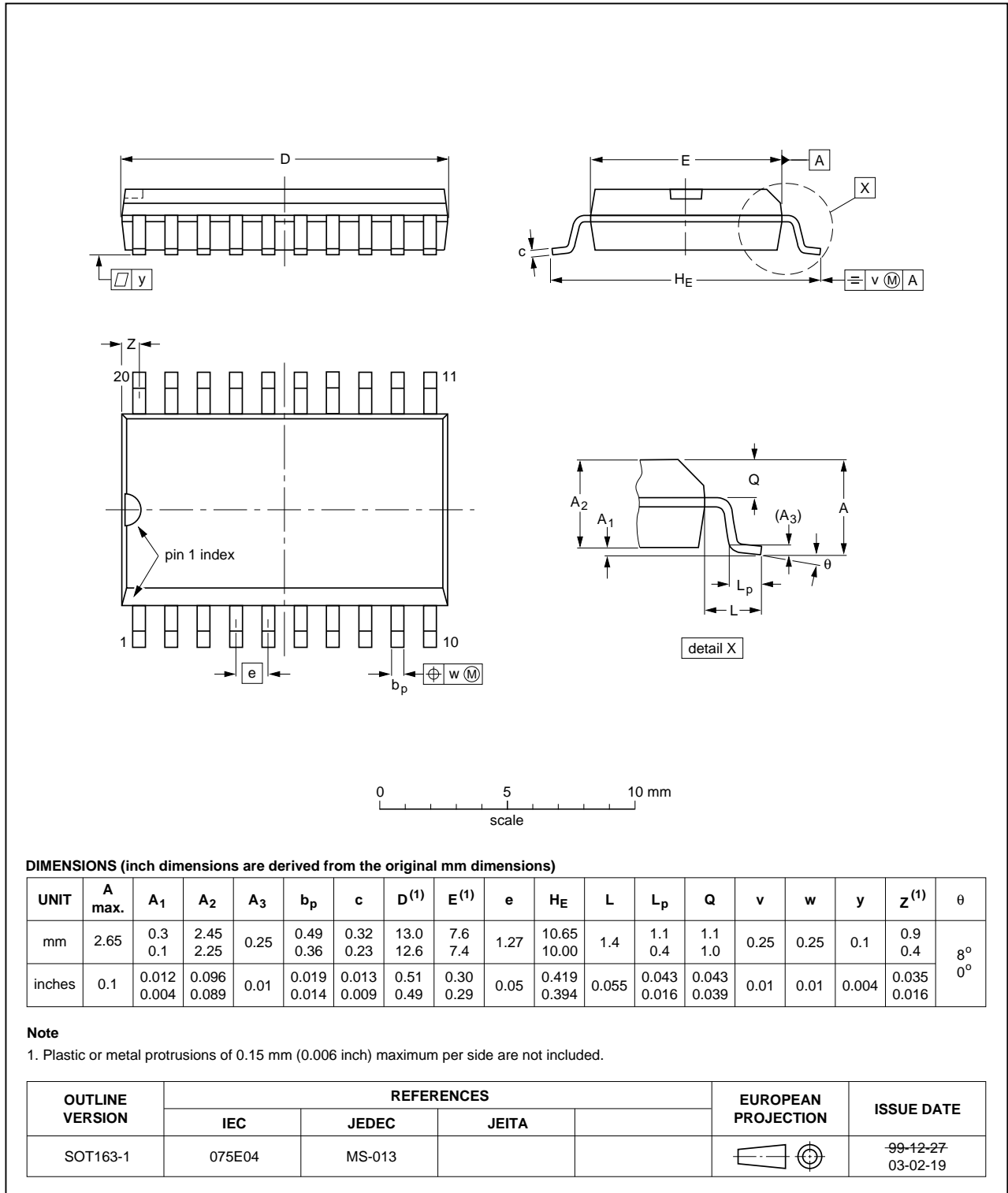


Fig 9. Package outline SOT163-1 (SO20)

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1

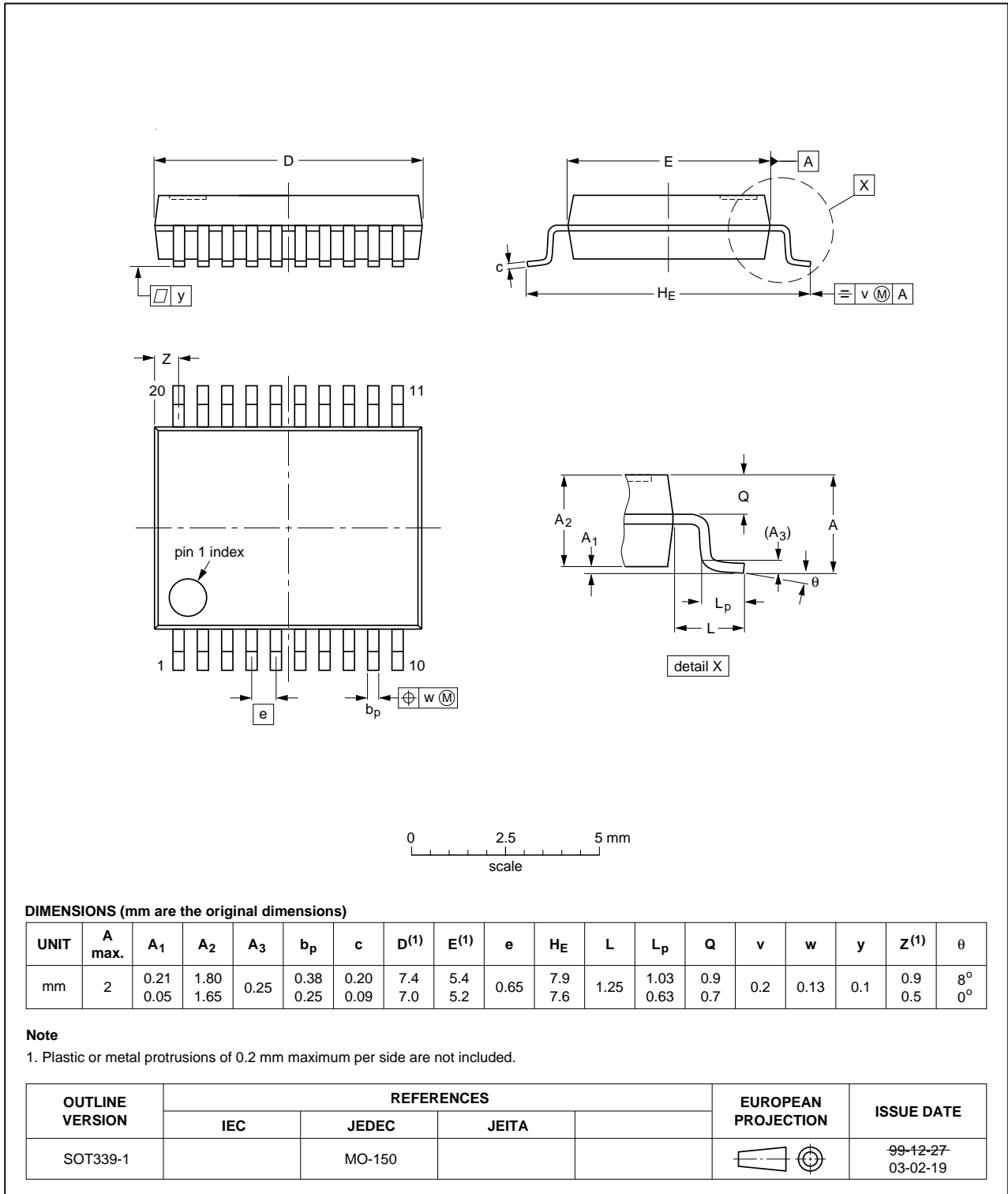


Fig 10. Package outline SOT339-1 (SSOP20)

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

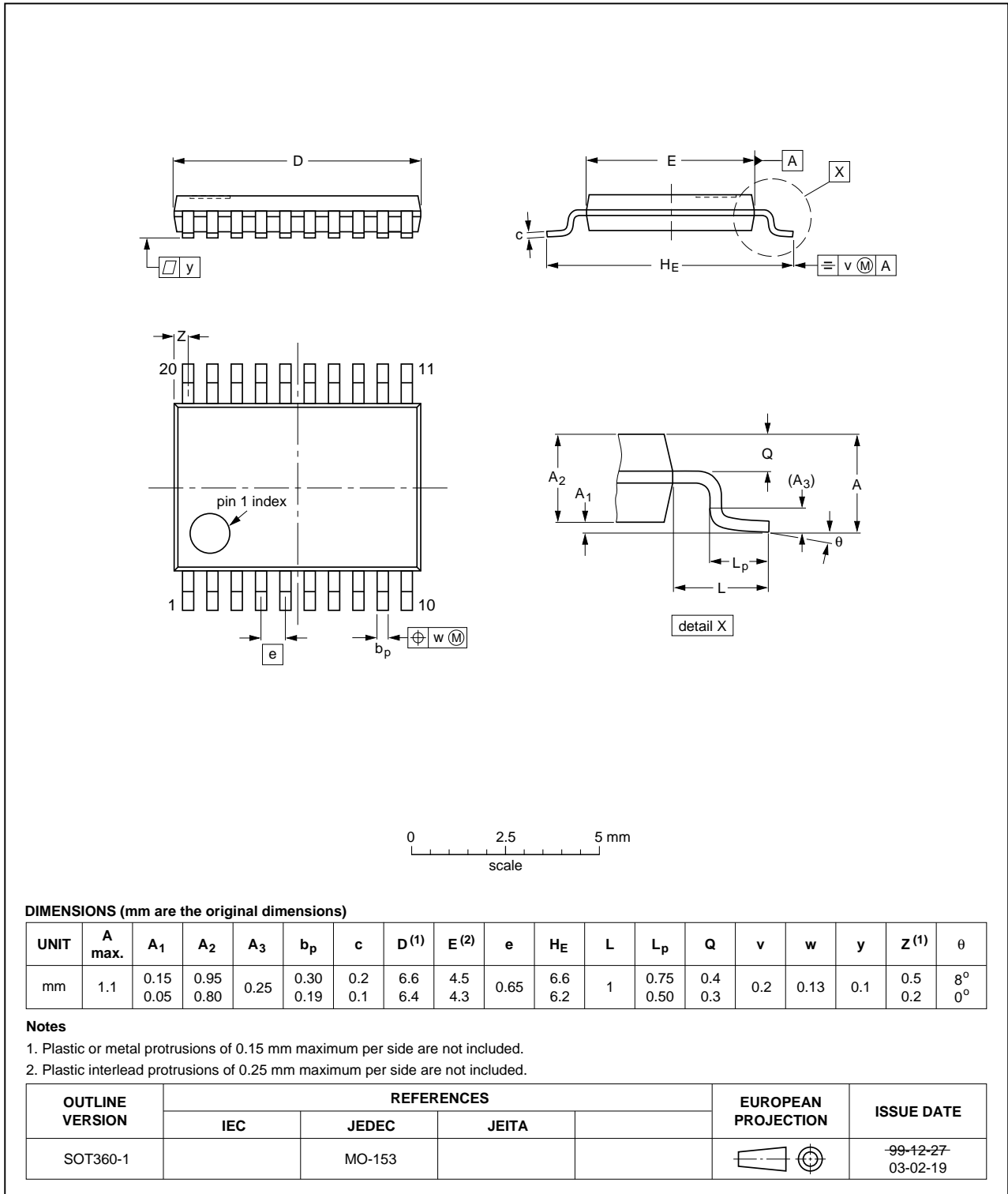


Fig 11. Package outline SOT 360-1 (TSSOP20)

## 13. Abbreviations

Table 10. Abbreviations

| Acronym | Description                 |
|---------|-----------------------------|
| CDM     | Charged Device Model        |
| DUT     | Device Under Test           |
| ESD     | ElectroStatic Discharge     |
| HBM     | Human Body Model            |
| MM      | Machine Model               |
| TTL     | Transistor-Transistor Logic |

## 14. Revision history

Table 11. Revision history

| Document ID        | Release date | Data sheet status  | Change notice | Supersedes |
|--------------------|--------------|--------------------|---------------|------------|
| 74LVC623A_Q100 v.1 | 20130417     | Product data sheet | -             | -          |

## 15. Legal information

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| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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